



**TECH PUBLIC**

台舟电子

**TPM3155EX6-1**

20V N-Channel + P-Channel Enhancement Mode MOSFET

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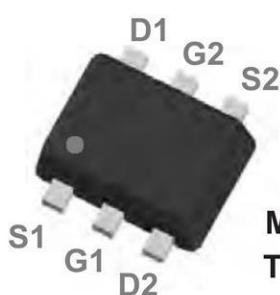
## Features

<b>V<sub>(BR)DSS</sub></b>	<b>R<sub>DS(on)MAX</sub></b>	<b>I<sub>D</sub></b>
20V	380mΩ@ 4.5V	0.75A
	450mΩ@ 2.5V	
	800mΩ@1.8V	
-20V	520mΩ@-4.5V	-0.66A
	700mΩ@-2.5V	
	950mΩ(TYP)@-1.8V	

- ESD Protected

## Package and Pin Configuration

SOT563

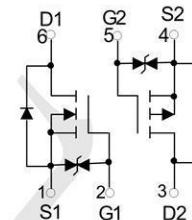


Marking: TW.P  
TW = Par Number  
P = TECH PUBLIC LOGO

## Application

- Notebook
- Load Switch
- Networking
- Hand-held Instruments

## Circuit diagram



## Absolute Maximum Ratings T<sub>c</sub>=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
<b>N-MOSFET</b>			
Drain-Source Voltage	V <sub>DS</sub>	20	V
Typical Gate-Source Voltage	V <sub>GS</sub>	±12	V
Continuous Drain Current (note 1)	I <sub>D</sub>	0.75	A
Pulsed Drain Current (tp=10us)	I <sub>DM</sub>	1.8	A
<b>P-MOSFET</b>			
Drain-Source Voltage	V <sub>DS</sub>	-20	V
Typical Gate-Source Voltage	V <sub>GS</sub>	±12	V
Continuous Drain Current (note 1)	I <sub>D</sub>	-0.7	A
Pulsed Drain Current (tp=10us)	I <sub>DM</sub>	-1.2	A
<b>Temperature and Thermal Resistance</b>			
Thermal Resistance from Junction to Ambient (note 1)	R <sub>θJA</sub>	833	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	T <sub>L</sub>	260	°C



**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

**N-ch MOSFET ELECTRICAL CHARACTERISTICS**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±10V, V <sub>DS</sub> = 0V			±20	uA
Gate threshold voltage (note 2)	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	0.45		1.1	V
Drain-source on-resistance(note 2)	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 0.65A			380	mΩ
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 0.55A			450	mΩ
		V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 0.45A			800	mΩ
Forward tranconductance(note 2)	g <sub>FS</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.8A		1.6		S
Diode forward voltage	V <sub>SD</sub>	I <sub>S</sub> = 0.15A, V <sub>GS</sub> = 0V			1.2	V
<b>DYNAMIC CHARACTERISTICS (note 4)</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V, f = 1MHz			120	pF
Output Capacitance	C <sub>oss</sub>				20	pF
Reverse Transfer Capacitance	C <sub>rss</sub>				15	pF
<b>SWITCHING CHARACTERISTICS (note 3,4)</b>						
Turn-on delay time	t <sub>d(on)</sub>	V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V, I <sub>D</sub> = 500mA, R <sub>GEN</sub> = 10Ω		6.7		ns
Turn-on rise time	t <sub>r</sub>			4.8		ns
Turn-off delay time	t <sub>d(off)</sub>			17.3		ns
Turn-off fall time	t <sub>f</sub>			7.4		ns

**P-ch MOSFET ELECTRICAL CHARACTERISTICS**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V			-1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±10V, V <sub>DS</sub> = 0V			±20	uA
Gate threshold voltage (note 2)	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-0.45		-1.1	V
Drain-source on-resistance(note 2)	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1A		270	520	mΩ
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -0.8A		320	700	mΩ
		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -0.5A		950		mΩ
Forward tranconductance(note 2)	g <sub>FS</sub>	V <sub>DS</sub> = -10V, I <sub>D</sub> = -0.54A		1.2		S
Diode forward voltage	V <sub>SD</sub>	I <sub>S</sub> = -0.5A, V <sub>GS</sub> = 0V			-1.2	V
<b>DYNAMIC CHARACTERISTICS (note 4)</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V, f = 1MHz			170	pF
Output Capacitance	C <sub>oss</sub>				25	pF
Reverse Transfer Capacitance	C <sub>rss</sub>				15	pF
<b>SWITCHING CHARACTERISTICS (note 3,4)</b>						
Turn-on delay time	t <sub>d(on)</sub>	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V, I <sub>D</sub> = -200mA, R <sub>GEN</sub> = 10Ω		9		ns
Turn-on rise time	t <sub>r</sub>			5.8		ns
Turn-off delay time	t <sub>d(off)</sub>			32.7		ns
Turn-off fall time	t <sub>f</sub>			20.3		ns



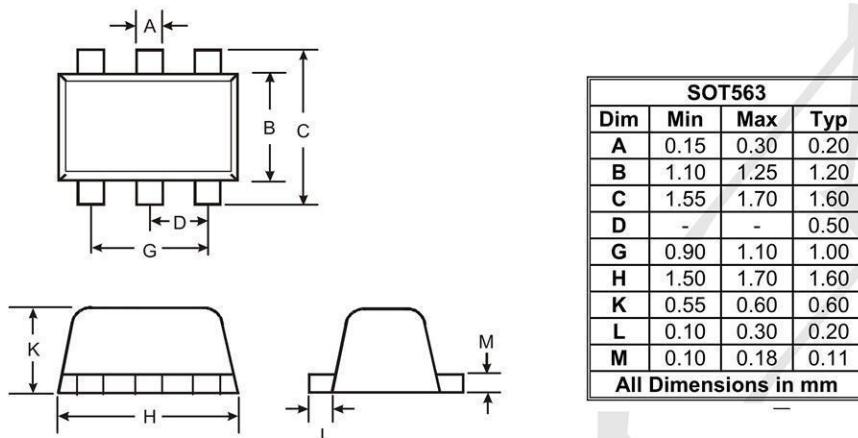
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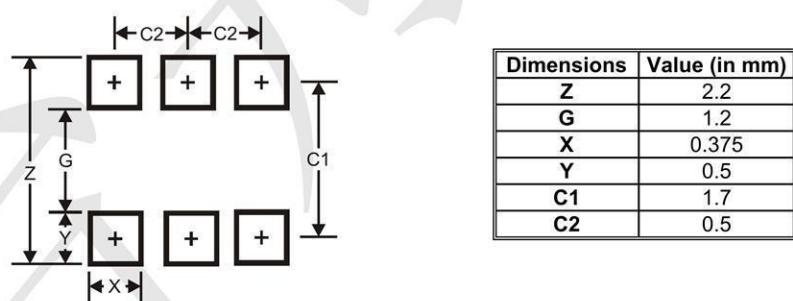
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### SOT-563 Package Outline Drawing



### Suggested Pad Layout



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